

Features

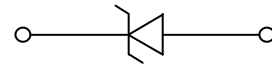
- 200W peak pulse power ($t_p = 8/20\mu s$)
- SOD-523 package
- Fast response time, typically $< 1\text{ ns}$
- Excellent clamping voltage
- Low leakage current
- IEC 61000-4-2 $\pm 15\text{kV}$ (Air) ESD protection
- IEC 61000-4-2 $\pm 8\text{kV}$ (Contact) ESD protection
- IEC 61000-4-4 40A (5/50ns) EFT protection
- RoHS compliant



SOD-523

Applications

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies



Schematic Diagram

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power ($T_P = 8/20\mu s$)	P_{PP}	200	W
Peak Pulse Current ($T_P = 8/20\mu s$)	I_{PP}	10	A
Junction Temperature	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Reverse stand-off Voltage	V_{RWM}	-	-	-	7	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	7.5	-	-	V
Reverse Leakage Current	I_R	$V_R = 7\text{V}$	-	-	1	μA
Clamping Voltage	V_C	$I_{PP} = 5\text{A}, T_P = 8/20\mu s$	-	-	13.5	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}, T_P = 8/20\mu s$	-	-	16	V
Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	-	80	-	pF

Typical Characteristic Curves

Fig.1 Peak Pulse Power vs Pulse Time

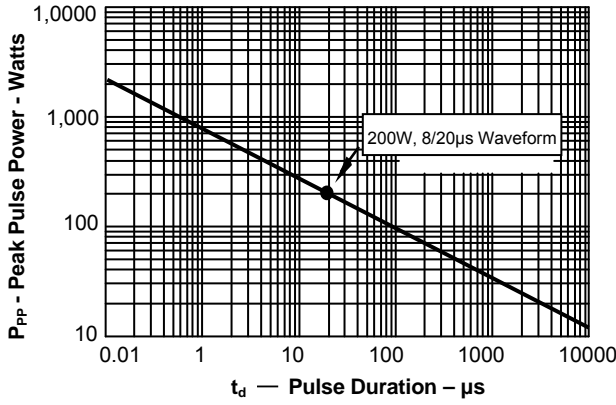


Fig.2 Pulse WaveForm-8/20μs

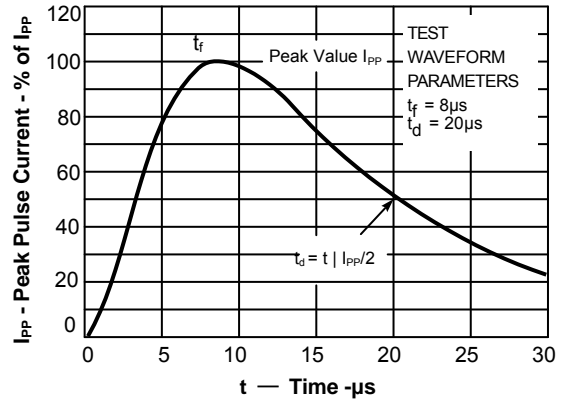


Fig.3 Power Derating Curve

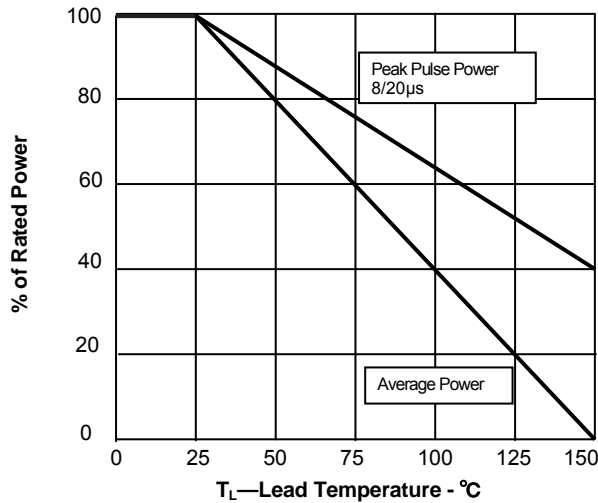
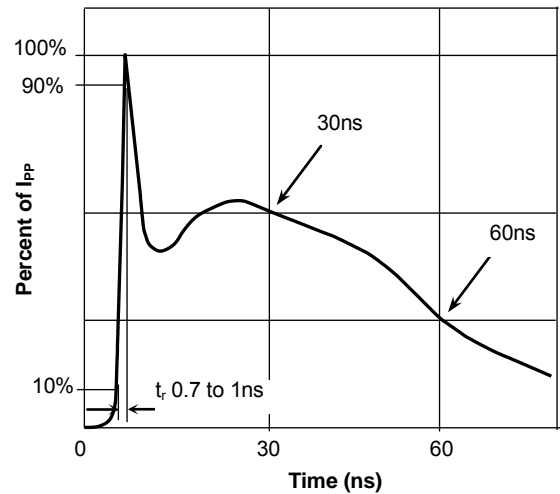
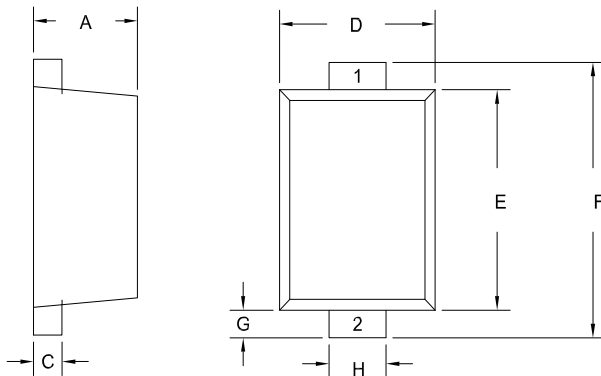


Fig.4 Pulse Waveform-ESD(IEC61000-4-2)



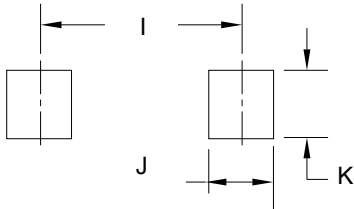
Product Dimensions

SOD-523



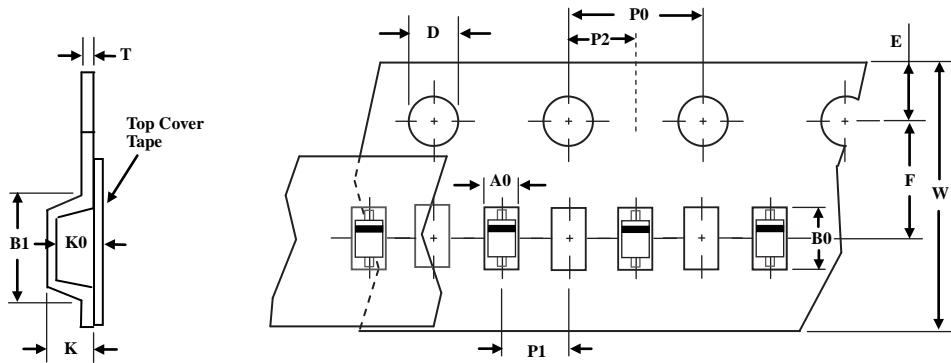
Dim	mm	
	min	max
A	0.50	0.70
C	0.07	0.20
D	0.70	0.90
E	1.10	1.30
F	1.50	1.70
G	0.15	0.25
H	0.25	0.35

PAD Dimensions



Dim	mm	
	min	max
I	1.35	
J	0.35	
K	0.39	

Package Information



TapeSize(W)	B1 max	D	E	F	K max	P0	P1	P2	T max	W max
8	4.55	1.55±0.05	1.75±0.1	3.5±0.05	2.4	4.0±0.1	2.0±0.05	2.0±0.05	0.6	8.3

Note: 1. unit : mm

2. A0, B0, and K0 are determined by component size. The clearance between the components and the cavity must be within 0.05mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity.

Marking

